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### Hex Inverters with Open Drain Outputs



ADE-205-249C (Z)

4th Edition Jul. 2001

#### **Description**

The HD74LV05A has six inverters with open drain outputs in a 14-pin package.

Low-voltage and high-speed operation is suitable for the battery-powered products (e.g., notebook computers), and the low-power consumption extends the battery life.

#### **Features**

- $V_{CC} = 2.0 \text{ V to } 5.5 \text{ V operation}$
- All inputs  $V_{IH}$  (Max.) = 5.5 V (@ $V_{CC}$  = 0 V to 5.5 V)
- All outputs  $V_0$  (Max.) = 5.5 V (@ $V_{CC}$  = 0 V)
- All outputs  $V_0$  (Max.) = 5.5 V (@ $V_{cc}$  = 2.0 V to 5.5 V, Output "Z" state)
- Typical  $V_{OL}$  ground bounce < 0.8 V (@ $V_{CC}$  = 3.3 V, Ta = 25°C)
- Output current  $\pm 6 \text{ mA}$  (@V<sub>CC</sub> = 3.0 V to 3.6 V),  $\pm 12 \text{ mA}$  (@V<sub>CC</sub> = 4.5 V to 5.5 V)

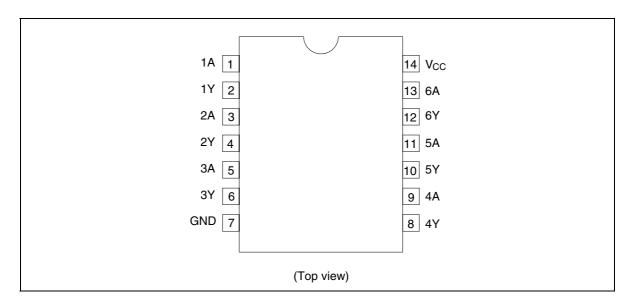
#### **Function Table**

Input A	Output Y
L	Z
Н	L

Note: H: High level L: Low level

Z: High impedance

### Pin Arrangement



### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	-0.5 to 7.0	V	
Input voltage range*1	V,	-0.5 to 7.0	V	
Output voltage range*1,2	V <sub>o</sub>	$-0.5$ to $V_{cc} + 0.5$	V	Output: Z or L
		-0.5 to 7.0	_	V <sub>cc</sub> : OFF
Input clamp current	I <sub>IK</sub>	-20	mA	V <sub>1</sub> < 0
Output clamp current	I <sub>ok</sub>	±50	mA	V <sub>0</sub> < 0
Continuous output current	Io	±25	mA	$V_o = 0$ to $V_{cc}$
Continuous current through $V_{cc}$ or GND	I <sub>CC</sub> or I <sub>GND</sub>	±50	mA	
Maximum power dissipation at Ta = 25°C (in still air) *3	P <sub>T</sub>	785	mW	SOP
		500	=	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

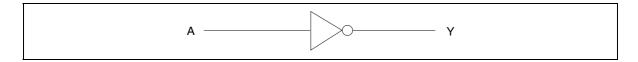
- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 7.0 V maximum.
- 3. The maximum package power dissipation was calculated using a junction temperature of 150°C.

### **Recommended Operating Conditions**

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V <sub>cc</sub>	2.0	5.5	V	
Input voltage range	V <sub>i</sub>	0	5.5	V	
Output voltage range	V <sub>o</sub>	0	5.5	V	
Output current	I <sub>OL</sub>	_	50	μΑ	V <sub>cc</sub> = 2.0 V
		_	2	mA	V <sub>cc</sub> = 2.3 to 2.7 V
		_	6		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		_	12		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Input transition rise or fall rate	Δt / Δν	0	200	ns/V	V <sub>cc</sub> = 2.3 to 2.7 V
		0	100		$V_{cc} = 3.0 \text{ to } 3.6 \text{ V}$
		0	20		$V_{cc} = 4.5 \text{ to } 5.5 \text{ V}$
Operating free-air temperature	Та	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

### Logic Diagram



#### **DC Electrical Characteristics**

 $Ta = -40 \text{ to } 85^{\circ}\text{C}$ 

Item	Symbol	V <sub>cc</sub> (V) *	Min	Тур	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>	2.0	1.5	_	_	V	
		2.3 to 2.7	$V_{cc} \times 0.7$	_	_	-	
		3.0 to 3.6	$V_{cc} \times 0.7$	_	_	-	
		4.5 to 5.5	$V_{cc} \times 0.7$	_	_	-	
	V <sub>IL</sub>	2.0	_	_	0.5	-	
		2.3 to 2.7	_	_	$V_{cc} \times 0.3$	-	
		3.0 to 3.6	_	_	$V_{cc} \times 0.3$	-	
		4.5 to 5.5	_	_	$V_{cc} \times 0.3$	-	
Output voltage	$V_{oL}$	Min to Max	_	_	0.1	V	$I_{OL} = 50 \mu A$
		2.3	_	_	0.4	-	I <sub>OL</sub> = 2 mA
		3.0	_	_	0.44	-	I <sub>oL</sub> = 6 mA
		4.5	_	_	0.55	-	I <sub>OL</sub> = 12 mA
Input current	I <sub>IN</sub>	0 to 5.5	_	_	±1	μΑ	V <sub>IN</sub> = 5.5 V or GND
Off state output current	l <sub>oz</sub>	Min to Max	_	_	±2.5	μΑ	V <sub>o</sub> = 5.5 V
Quiescent supply current	I <sub>cc</sub>	5.5	_	_	20	μΑ	$V_{IN} = V_{CC}$ or GND, $I_{O} = 0$
Output leakage current	I <sub>OFF</sub>	0	_	_	5	μА	$V_1$ or $V_0 = 0$ to 5.5 V
Input capacitance	C <sub>IN</sub>	3.3	_	2.3	_	pF	$V_{I} = V_{CC}$ or GND

Note: For conditions shown as Min or Max use the appropriate values under recommended operating conditions.

### **Switching Characteristics**

 $V_{cc} = 2.5 \pm 0.2 \text{ V}$ 

		Ta = 2	25°C		Ta =	40 to 85°C				
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation	t <sub>PLH</sub>	_	4.7	10.4	1.0	13.0	ns	C <sub>∟</sub> = 15 pF	Α	Υ
delay time		_	9.5	15.2	1.0	18.0	_	C <sub>L</sub> = 50 pF	-	
	t <sub>PHL</sub>	_	5.4	10.4	1.0	13.0	_	C <sub>L</sub> = 15 pF	•	
			7.9	15.2	1.0	18.0	_	C <sub>∟</sub> = 50 pF	•	

$$V_{cc} = 3.3 \pm 0.3 \text{ V}$$

		Ta = 2	25°C		Ta = -4	40 to 85°C				
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation	t <sub>PLH</sub>	_	4.0	7.1	1.0	8.5	ns	C <sub>∟</sub> = 15 pF	Α	Υ
delay time		_	7.3	10.6	1.0	12.0	_	C <sub>L</sub> = 50 pF	=	
	t <sub>PHL</sub>	_	4.3	7.1	1.0	8.5	_	C <sub>∟</sub> = 15 pF	-	
		_	5.8	10.6	1.0	12.0	_	C <sub>∟</sub> = 50 pF	=	

$$V_{cc} = 5.0 \pm 0.5 \text{ V}$$

		Ta = 2	25°C		$Ta = -40 \text{ to } 85^{\circ}\text{C}$					
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Test Conditions	FROM (Input)	TO (Output)
Propagation	t <sub>PLH</sub>	_	3.3	5.5	1.0	6.5	ns	C <sub>L</sub> = 15 pF	Α	Υ
delay time		_	5.6	7.5	1.0	8.5	_	C <sub>L</sub> = 50 pF	-	
	t <sub>PHL</sub>	_	3.4	5.5	1.0	6.5	_	C <sub>L</sub> = 15 pF	-	
		_	4.1	7.5	1.0	8.5	_	C <sub>L</sub> = 50 pF	-	_

### **Operating Characteristics**

 $C_L = 50 \text{ pF}$ 

Ta	=	25°	C

Item	Symbol	$V_{cc}$ (V)	Min	Тур	Max	Unit	<b>Test Conditions</b>
Power dissipation capacitance	$C_{\scriptscriptstylePD}$	3.3	_	2.5	_	pF	f = 10 MHz
		5.0	_	3.0	_		

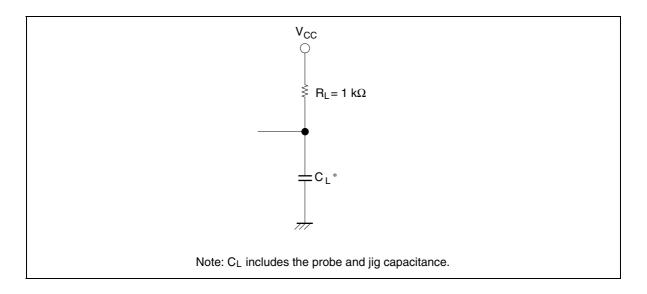
### **Noise Characteristics**

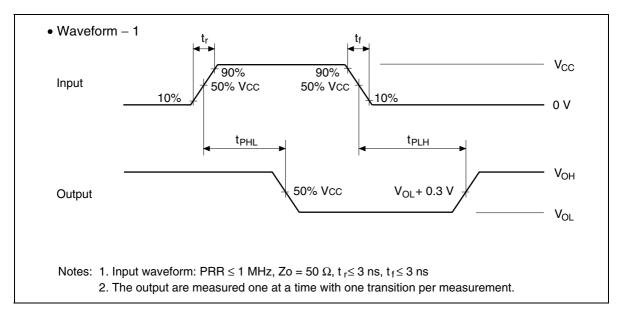
 $C_L = 50 \text{ pF}$ 

т	•	_	25	0
	а	=	23	•

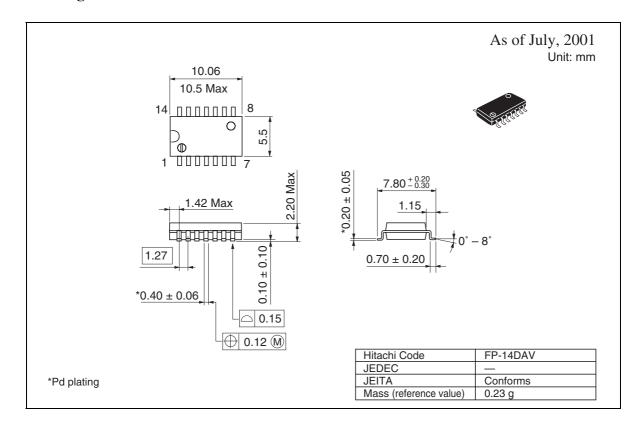
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	 Unit	Test Conditions
Quiet output, maximum dynamic V <sub>oL</sub>	V <sub>OL (P)</sub>	3.3		0.3	0.8	V	rest Conditions
	V <sub>OL (V)</sub>	3.3	_	-0.1	-0.8		
High-level dynamic input voltage	V <sub>IH (D)</sub>	3.3	2.31	_	_	V	_
Low-level dynamic input voltage	$V_{_{IL\;(D)}}$	3.3	_	_	0.99		

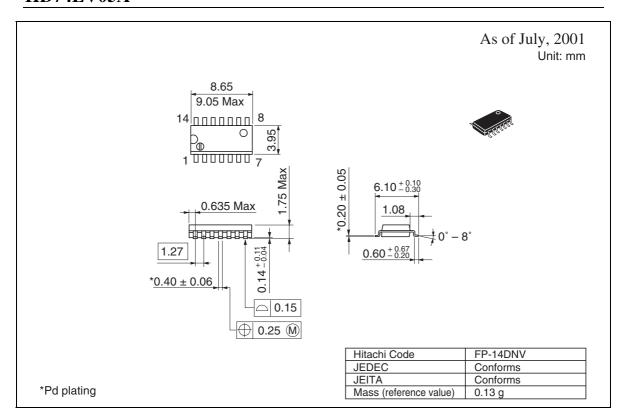
#### **Test Circuit**

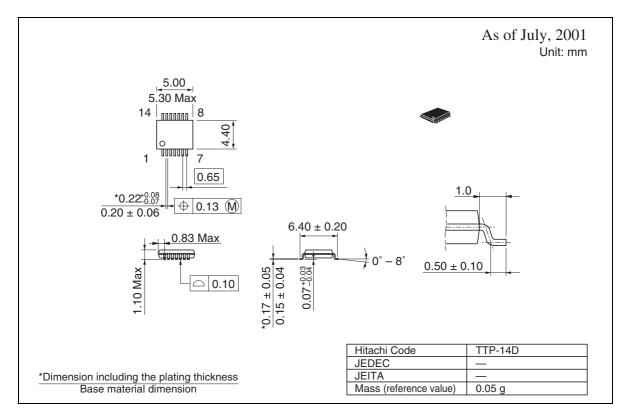




### **Package Dimensions**







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#### Sales Offices

### ITACHI

Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL

NorthAmerica : http://semiconductor.hitachi.com/ Europe http://www.hitachi-eu.com/hel/ecg Asia http://sicapac.hitachi-asia.com Japan http://www.hitachi.co.jp/Sicd/indx.htm

#### For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Germany

Hitachi Europe GmbH Electronic Components Group Dornacher Strage 3 D-85622 Feldkirchen, Munich Fax: <1>(408) 433-0223 Tel: <49> (89) 9 9180-0

Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead

Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 585160

Hitachi Asia Ltd. Hitachi Tower 16 Collyer Quay #20-00, Singapore 049318 Tel: <65>-538-6533/538-8577

Fax: <65>-538-6933/538-3877 URL: http://www.hitachi.com.sg Hitachi Asia Ltd

(Taipei Branch Office) 4/F, No. 167, Tun Hwa North Road, Hung-Kuo Building, Taipei (105), Taiwan Tel: <886>-(2)-2718-3666 Fax: <886>-(2)-2718-8180

Telex: 23222 HAS-TP URL: http://www.hitachi.com.tw

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Hong Kong

Hitachi Asia (Hong Kong) Ltd.

7/F., North Tower,

World Finance Centre,

Harbour City, Canton Road

Tsim Sha Tsui, Kowloon,

Tel: <852>-(2)-735-9218

Fax: <852>-(2)-730-0281

URL: http://www.hitachi.com.hk

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